Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
HAI JU NO	05/03/2007
HEE SUNG KIM	05/03/2007
JUNG BUM WOO	05/03/2007
SANG NAM GO	05/03/2007
TAE HYUNG KIM	05/03/2007

RECEIVING PARTY DATA

Name:	HYNIX SEMICONDUCTOR INC.	
Street Address:	San 136-1, Ami-ri, Bubal-eub, Icheon-si	
City:	Kyoungki-do	
State/Country:	KOREA, REPUBLIC OF	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	11746686

CORRESPONDENCE DATA

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Address Line 4: CHICAGO, ILLINOIS 60604

ATTORNEY DOCKET NUMBER:	CU-5675 WWP/NK
NAME OF SUBMITTER:	Woochoon W. Park

Total Attachments: 2

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PATENT REEL: 019274 FRAME: 0024

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PATENT REEL: 019274 FRAME: 0025

UNITED STATES OF AMERICA ASSIGNMENT

In consideration of the payment of ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for the other good and valuable consideration,

ASSIGNOR:

Name: Hai Ju NO

Address: 3rd Floor, 1524 Yongam-dong, Sangdang-gu, Cheongju-si, Chungcheongbuk-do,

Korea

Name: Hee Sung KIM

Address: 120-302, Uncheon Jugong Apt., 528 Sinbong-dong, Cheongju-si, Chungcheongbuk-

do, Korea

Name: Jung Bum WOO

Address: #102, 6th Yeongsin Villa, 1006-4, Bongmyeong-dong, Heungdeok-gu, Cheongju-si,

Chungcheongbuk-do, Korea

Name: Sang Nam GO

Address: 405-1503, Sannam Jugong Apts. 4, Sugok-dong, Heungdeok-gu, Cheongju-si,

Chungcheongbuk-do, Korea Name: Tae Hyung KIM

Address: #423, New Bldg., Man's Dormitory, Hyangjeong-dong, Heungdeok-gu, Cheongju-

si, Chungcheongbuk-do, Korea

(INVENTOR NAME AND ADDRESS)

hereby sells, assigns and transfers to

ASSIGNEE:

Name: Hynix Semiconductor Inc.

Address: San 136-1, Ami-ri, Bubal-eub, Icheon-si, Kyoungki-do, Korea

(ASSIGNEE NAME AND ADDRESS)

and the successors, assigns and legal representatives of the ASSIGNEE the entire right, title and interest for the United States and its territorial possessions in and to, any and all improvements which are disclosed in the invention entitled:

BALL ATTACHING APPARATUS FOR CORRECTING WARPAGE OF SUBSTRATE AND METHOD OF ATTACHING SOLDER BALLS USING THE SAME

(TITLE)

and which is found in (check one applicable item below)

☑ U.S. patent application executed on even date herewith

VIVIX 특허문서

192.168.27.119 / 2007. 04. 25 13:41 / B42050 / B03234

PATENT REEL: 019274 FRAME: 0026

☐ U.S. Application Serial No	o filed on
	e obtained for said invention by the above application or abstitute, reissue or re-examination thereof.
ASSIGNOR hereby convenar has been or will be made or entered in	nts that no assignment, sale agreement or encumbrance ato which would conflict with this assignment and sale;
Patent and legal equivalents as may be to the same in any interference or li- deliver to ASSIGNEE or its legal rep- required to apply for, obtain, maintain	nts that ASSIGNEE will, upon its request, be provided if documents relating to said invention and said Letters is known and accessible to ASSIGNOR and will testify as itigation related thereto and will promptly execute and presentatives any and all papers, instruments or affidavits in, issue and enforce said application, said invention and ints thereof which may be necessary or desirable to carry
IN WITNESS WHEREOF, I/	we have set our hand and seal
May 3, 2007	Hai Tu Wo
Date	INVENTOR: Hai Ju NO
May 3, 2007	Hee Suny Kim
Date **	INVENTOR: Hee Sung KIM
May 3, 2007	Jung Bum Woo
Date	INVENTOR: Jung Bum WOO
May 3, 2007	Sany Nom Go
Date	INVENTOR: Sang Nam GO
May 3, 2007	Too Herran Kim
Date	INVENTOR: Tae Hyung KIM

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RECORDED: 05/10/2007

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